

LNPT[™] COLORCOMP[™] COMPOUND J1000

DESCRIPTION

LNP COLORCOMP J1000 compound is based on unfilled Polyethersulfone (PES) resin.

GENERAL INFORMATION

Features	Aesthetics/Visual effects, High temperature resistance, No PFAS intentionally added
Fillers	Unreinforced
Polymer Types	Polyethersulfone (PESU)
Processing Techniques	Injection Molding

INDUSTRY

Automotive
Consumer
Electrical and Electronics
Industrial

SUB INDUSTRY

Automotive Interiors
Sport/Leisure, Personal Accessory, Home Appliances, Commercial Appliance
Mobile Phone - Computer - Tablets
Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yield, 50 mm/min	91	MPa	ISO 527
Tensile Stress, break, 50 mm/min	67	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	6.8	%	ISO 527
Tensile Modulus, 1 mm/min	2700	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	128	MPa	ISO 178
Flexural Modulus, 2 mm/min	2600	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched 80*10*4 +23°C	NB	kJ/m ²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	7	kJ/m ²	ISO 180/1A
THERMAL ⁽¹⁾			
CTE, 23°C to 60°C, flow	5.9E-05	1/°C	ISO 11359-2
CTE, 23°C to 60°C, xflow	5.9E-05	1/°C	ISO 11359-2
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	216	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	201	°C	ISO 75/Af
PHYSICAL ⁽¹⁾			
Mold Shrinkage, flow ⁽²⁾	1	%	SABIC method
Density	1.37	g/cm ³	ISO 1183
Water Absorption, (23°C/24hrs)	0.6	%	ISO 62-1
FLAME CHARACTERISTICS ⁽³⁾			
UL Yellow Card Link	E45329-101282591	-	-
UL Yellow Card Link 2	E121562-101282575	-	-

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
UL Recognized, 94V-0 Flame Class Rating	0.5	mm	UL 94
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120 – 150	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.05	%	
Melt Temperature	355 – 370	°C	
Front - Zone 3 Temperature	370 – 380	°C	
Middle - Zone 2 Temperature	360 – 370	°C	
Rear - Zone 1 Temperature	345 – 355	°C	
Mold Temperature	140 – 150	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	60 – 100	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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